Product summary

MAYA-W4 series

Host-based Wi-Fi 6 multiradio modules for the IoT

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Cost-efficient, small, secure modules for IoT applications

- Single- and dual-band Wi-Fi 6 1x1, 20 MHz channels
- Bluetooth Low Energy 5.4
- 802.15.4 radio supporting Thread
- · Matter over Wi-Fi and Thread
- Variants with PCB-antenna, U.FL connector(s), and antenna pin(s)
- Secure boot, firmware, OTP memory, NXP Edgelock®

10.4 x 14.3 × 1.9 mm









Product description

The MAYA-W4 series host-based modules are designed, built, and tested to meet the high reliability and quality requirements of industrial and commercial applications, such as building automation, professional appliances, energy management, smart homes, healthcare, and more.

MAYA-W4 modules provide SISO Wi-Fi 6 operation with 20 MHz channel width and improved network availability in dense Wi-Fi environments. The modules can work as access point, station, in P2P connections, or combinations of these.

MAYA-W4 supports Bluetooth Low Energy 5.4, including the use of isochronous channels for LE Audio. W44x and W47x variants support IEEE 802.15.4 radio for Thread mesh network support. The Matter application protocol is supported over Thread and Wi-Fi allowing interoperability with various products in a growing ecosystem.

At 10.4 x 14.3 mm, MAYA-W4 are among the most compact Wi-Fi 6 SMD modules with integrated antenna or U.FL

All u-blox modules undergo extensive qualification tests to ensure reliability over their life-time, and each module is fully tested before leaving the assembly line.

The MAYA-W4 series is based on the NXP IW610x chipsets.

Kev features

- · Variants with antenna pins, U.FL connectors, and embedded PCB antenna
- · Wi-Fi 6, single- and dual-band, single stream, supporting MU-MIMO, 20 MHz channels
- Wi-Fi 802.11a/b/q/n/ac/ax/ e/i/k/r/v/w
- Wi-Fi security: WPA3, WPA2, AES
- Bluetooth 5.4 supporting LE Audio
- 802.15.4 radio for Thread
- Secure operation (Edgelock™), secure boot
- Industrial temperature range -40 °C to +85 °C

| Crade | | .W43 | W44 | .W46 | .W47 | .W47 |
|---|------------------------------------|------|-----------|---------|-----------|-------|
| Grade | | AYA- | AYA- | AYA- | AYA- | AYA- |
| Automotive Professional Standard Radio Chip inside Bluetooth qualification Bluetooth Low Energy Bluetooth Low Energy Bluetooth output power [dBm] Wi-Fi IEEE 802.11 standards Wi-Fi frequency band [GHz] 802.15.4 radio Wi-Fi output power [dBm] Antenna type Number of antennas OS support Android / Linux drivers (from NXP) RTOS (via NXP i.MX RT MCUs) Interfaces High-speed UART (Bluetooth) USB (Wi-Fi) [version] SDIO (Wi-Fi) [version] SDIO (Wi-Fi) [version] SPI (802.15.4) Features Micro access point [max connects] Wi-Fi direct WPA3 RF calibration in OTP Programmed MAC address NXP 610x NXP 610x NXP 610x NXP 610x NXP 610x | Over the | Σ | Σ | Σ | Σ | Σ |
| Professional Standard Radio Chip inside Bluetooth qualification W5.4 (Low Energy) HCl Sluetooth profiles HCl Up to 15 Wi-Fi EEE 802.11 standards Wi-Fi 6 (802.11a/b/g/n/ac/ax) Wi-Fi frequency band [GHz] 2.4 2.4 2.4/5 2.4/5 2.4/5 2.4/5 802.15.4 radio Wi-Fi output power [dBm] 18 18 18 18 18 18 18 Antenna type pin U.FL pin pin pcb Number of antennas 1 1 1 2 1 1 1 2 1 1 | | | | | | |
| Radio Chip inside Bluetooth qualification Bluetooth profiles Bluetooth profiles Bluetooth Low Energy Sluetooth Low Energy Sluetooth output power [dBm] Wi-Fi 1EEE 802.11 standards Wi-Fi 6 (802.11a/b/g/n/ac/ax) Wi-Fi frequency band [GHz] 2.4 2.4 2.4/5 2.4/5 2.4/5 2.4/5 802.15.4 radio Support 2.4 2.4 2.4/5 2.4/5 2.4/5 2.4/5 802.15.4 radio Support 2.5 2.5 2.4/5 2.4/5 2.4/5 2.4/5 802.15.4 radio Support 2.5 2.5 2.4/5 2 | | • | • | • | • | • |
| Chip inside Bluetooth qualification Bluetooth profiles Bluetooth Low Energy Bluetooth Low Energy Bluetooth Low Energy Bluetooth output power [dBm] Up to 15 Wi-Fi feequency band [GHz] 2.4 2.4 2.4/5 2.4/5 2.4/5 2.4/5 802.15.4 radio UFL pin pin pcb Post part of antennas 1 1 1 2 1 1 1 2 1 1 | | | | | | |
| Bluetooth qualification | | | | NIVE C1 | 0 | |
| Bluetooth profiles Bluetooth Low Energy Bluetooth output power [dBm] Wi-Fi IEEE 802.11 standards Wi-Fi frequency band [GHz] 802.15.4 radio Wi-Fi output power [dBm] Antenna type Number of antennas OS support Android / Linux drivers (from NXP) RTOS (via NXP i.MX RT MCUs) Interfaces High-speed UART (Bluetooth) USB (Wi-Fi) SDIO (Wi-Fi) [version] SPI (802.15.4) Features Micro access point [max connects] Wi-Fi direct WPA3 RF calibration in OTP Programmed MAC address Wi-Fi 6 (802.11a/b/g/n/ac/ax) Vu-Fi 10 (U-FL pin pin pcb Vu-Fi 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | • | | _ | | | |
| Bluetooth Low Energy Bluetooth output power [dBm] Wi-Fi IEEE 802.11 standards Wi-Fi frequency band [GHz] 802.15.4 radio Wi-Fi output power [dBm] Antenna type Number of antennas OS support Android / Linux drivers (from NXP) RTOS (via NXP i.MX RT MCUs) Interfaces High-speed UART (Bluetooth) USB (Wi-Fi) SDIO (Wi-Fi) [version] SPI (802.15.4) Features Micro access point [max connects] Wi-Fi direct WPA3 RF calibration in OTP Programmed MAC address Wi-Fi 6 (802.11a/b/g/n/ac/ax) USI-1 in to 15 Vui-Fi 6 (802.11a/b/g/n/ac/ax) Vui-Fi 6 (802.15a) Vui-Fi (1bux) Vui-Fi | | | V5.4 | | nergy) | |
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| Wi-Fi IEEE 802.11 standards Wi-Fi 6 (802.11a/b/g/n/ac/ax) Wi-Fi frequency band [GHz] 2.4 2.4 /5 /2.4/5 /2.4/5 /2.4/5 2.4/5 /2.4/5 /2.4/5 /2.4/5 802.15.4 radio . < | Bluetooth Low Energy | • | • | • | • | • |
| Wi-Fi frequency band [GHz] 2.4 2.4 2.4/5 2.4 | Bluetooth output power [dBm] | | | up to 1 | 5 | |
| 802.15.4 radio • • • • Wi-Fi output power [dBm] 18 18 18 18 18 18 Antenna type pin U.FL pin pin pin pcb Number of antennas 1 1 1 1 2 1 OS support Android / Linux drivers (from NXP) • • • • • • RTOS (via NXP i.MX RT MCUs) • • • • • • Interfaces Interfaces High-speed UART (Bluetooth) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | Wi-Fi IEEE 802.11 standards | W | i-Fi 6 (8 | 02.11a/ | b/g/n/ac, | /ax) |
| Wi-Fi output power [dBm] 18 11 11 11 1 1 1 1 1 1 1 1 | Wi-Fi frequency band [GHz] | 2.4 | 2.4 | 2.4/5 | 2.4/5 | 2.4/5 |
| Antenna type | 802.15.4 radio | | • | | • | • |
| Number of antennas 1 1 1 2 1 OS support Android / Linux drivers (from NXP) • | Wi-Fi output power [dBm] | 18 | 18 | 18 | 18 | 18 |
| OS support Android / Linux drivers (from NXP) • • • • • • • | Antenna type | pin | U.FL | pin | pin | pcb |
| Android / Linux drivers (from NXP) RTOS (via NXP i.MX RT MCUs) Interfaces High-speed UART (Bluetooth) USB (Wi-Fi) SDIO (Wi-Fi) [version] SPI (802.15.4) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | Number of antennas | 1 | 1 | 1 | 2 | 1 |
| RTOS (via NXP i.MX RT MCUs) • • • • • • • • • • • • • • • • • • • | OS support | | | | | |
| Interfaces | Android / Linux drivers (from NXP) | • | • | • | • | • |
| High-speed UART (Bluetooth) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 2.0 2.0 2.0 2.0 2.0 2.0 2.0 2.0 2.0 2.0 2.0 2.0 3.0 | RTOS (via NXP i.MX RT MCUs) | • | • | • | • | • |
| USB (Wi-Fi) 2.0 2.0 2.0 2.0 2.0 2.0 SDIO (Wi-Fi) [version] 3.0 3.0 3.0 3.0 3.0 SPI (802.15.4) 1 1 1 1 Features Micro access point [max connects] 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 | Interfaces | | | | | |
| SDIO (Wi-Fi) [version] 3.0 | High-speed UART (Bluetooth) | 1 | 1 | 1 | 1 | 1 |
| SPI (802.15.4) 1 1 1 Features | USB (Wi-Fi) | 2.0 | 2.0 | 2.0 | 2.0 | 2.0 |
| Features Micro access point [max connects] 8 8 8 8 Wi-Fi direct • • • • • WPA3 • • • • • • RF calibration in OTP • • • • • • • Programmed MAC address • • • • • • | SDIO (Wi-Fi) [version] | 3.0 | 3.0 | 3.0 | 3.0 | 3.0 |
| Micro access point [max connects] 8 8 8 8 Wi-Fi direct • • • • • WPA3 • • • • • RF calibration in OTP • • • • • Programmed MAC address • • • • • | SPI (802.15.4) | | 1 | | 1 | 1 |
| Wi-Fi direct WPA3 RF calibration in OTP Programmed MAC address • • • • • | Features | | | | | |
| WPA3 | Micro access point [max connects] | 8 | 8 | 8 | 8 | 8 |
| RF calibration in OTP • • • • • Programmed MAC address • • • • • | Wi-Fi direct | • | • | • | • | • |
| Programmed MAC address • • • • | WPA3 | • | • | • | • | • |
| J | RF calibration in OTP | • | • | • | • | • |
| Secure boot • • • • | Programmed MAC address | • | • | • | • | • |
| | Secure boot | • | • | • | • | • |

pin = antenna pin

U.FL = U.FL antenna connector





| Features | | |
|--------------------------|--|---|
| Wi-Fi standards | Wi-Fi 6 IEEE 802 IEEE 802.11d/e/i | |
| Wi-Fi channels | 2.4 GHz: 1-13 5 GHz: 36-177 | |
| Bluetooth | v5.4 LE long rang LE Audio | ge, power management, |
| 802.15.4 | IEEE 802.15.4 - 2 2.45 GHz, up to 2 | • |
| Antennas | MAYA-W433: 1 a MAYA-W442: 1 l MAYA-W463: 1 a MAYA-W471: 2 a MAYA-W476: 1 a | U.FL connector antenna pin |
| Wi-Fi output Tx-power | 18 dBm (Wi-Fi 6, | 5 GHz, 20 MHz channel) |
| RX sensitivity | Wi-Fi 6 2.4 GHz: Wi-Fi 6 5 GHz: Bluetooth LE: 802.15.4: | -95 dBm (indicative) -94 dBm (indicative) -100.5 dBm (@ 1 Mbps, indicative) -103 dBm (indicative) |
| Security | 128-bit AES hard Secure boot EdgeLock™ | dware encryption |

| Software | features |
|----------|----------|
|----------|----------|

| RF calibration | Available in on-board OTP memory |
|---|---|
| MAC addresses | Available in on-board OTP memory |
| Security | WPA2 (CCMP, AES) WPA3 |
| Wi-Fi operational modes | Station, access point, Wi-Fi direct, or any combination of these |
| Driver support | Free of charge drivers for Linux and Android |
| Wi-Fi/Bluetooth/ 802.15.4 coexistence | Internal coexistence between Wi-Fi and Bluetooth LE or 802.15.4 WCI-2 and PTA interface for external radio coexistence |

Interfaces

| Wi-Fi | SDIO 3.0 (4-bit, up to 208 MHz clock) USB 2.0 |
|-------------|--|
| Bluetooth | 4-wire high-speed UART |
| 802.15.4 | SPI |
| Coexistence | WCI-2 (2-wire) PTA |
| Other | GPIOs |

Package

| Dimensions | 10.4 × 14.3 × 1.9 mm |
|------------|--------------------------|
| Mounting | Soldering, 90 pins (LGA) |

Environmental data, quality, and reliability

| Operating temperature -40 °C to +85 °C |
|--|
| Moisture sensitivity level 4 |
| RoHS and REACH compliance |

Electrical data

| RF power supply | 3.13 – 3.46 VDC |
|------------------|--------------------|
| I/O power supply | 3.3 VDC or 1.8 VDC |

Certifications and approvals

| Type approvals | Europe (RED); US (FCC); Canada (ISED); Japan (Giteki) Other certifications will be considered upon request |
|----------------------------|---|
| Bluetooth qualification | v5.4 (Bluetooth Low Energy) |

Support products

| EVK-MAYA-W476 | Evaluation kit for MAYA-W476 |
|------------------|---|
| M2-MAYA-W473-10C | M2-MAYA-W473 module delivered as an evaluation kit together in a box with 1 patch antenna |

Product variants

| MAYA-W433-00B | Professional grade module with one antenna pin for single-band Wi-Fi and Bluetooth |
|---------------|---|
| MAYA-W442-00B | Professional grade module with one U.FL connector for single-band Wi-Fi, Bluetooth, and 802.15.4 |
| MAYA-W463-00B | Professional grade module with one antenna pin for dual-band Wi-Fi and Bluetooth |
| MAYA-W471-00B | Professional grade module with two separate antenna pins for dual-band Wi-Fi, Bluetooth, and 802.15.4 |
| MAYA-W476-00B | Professional grade module with embedded PCB antenna for dual-band Wi-Fi, Bluetooth, and 802.15.4 |

Further information

For contact information, see **www.u-blox.com/contact-u-blox**. For more product details and ordering information, see the product data sheet.

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